

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	3	"2002360312"	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/24 09:16
S3	2	carrier AND semiconductor AND wafer AND (resin OR polymer) AND (carbon ADJ (fiber OR fibre OR fibril)) AND (charge ADJ decay)	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/24 09:24
S4	115	carrier AND semiconductor AND wafer AND (resin OR polymer) AND (carbon ADJ (fiber OR fibre OR fibril)) AND charge	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/24 09:36
S5	38	S4 AND (polyetheretherketone OR polyetherimide OR polyethersulfone)	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/24 14:11
S6	3	carrier AND semiconductor AND wafer AND (resin OR polymer) AND (carbon ADJ (fiber OR fibre OR fibril)) AND charge	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 08:37
S7	1574	(524/496).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/18 08:45
S8	2	S7 AND carrier AND semiconductor AND wafer AND (resin OR polymer) AND (carbon ADJ (fiber OR fibre OR fibril)) AND charge	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/24 11:17
S9	5579	((524/542,592,602,606,612) or (525/184,420,422)).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/18 08:45
S10	3	S9 AND carrier AND semiconductor AND wafer AND (resin OR polymer) AND (carbon ADJ (fiber OR fibre OR fibril)) AND charge	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 08:45
S11	10568	(nakayama OR sugiyama OR tani).in.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/18 08:46
S12	0	S11 AND carrier AND semiconductor AND wafer AND (resin OR polymer) AND (carbon ADJ (fiber OR fibre OR fibril)) AND charge	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/24 11:19
S13	111	S11 AND carrier AND semiconductor AND wafer	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/24 11:19
S14	30	S11 AND carrier AND semiconductor AND wafer AND (resin OR polymer)	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/18 08:46
S15	1	(dainichi NEAR3 shoji NEAR3 kabushiki).as.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/18 08:47
S17	66	carrier AND semiconductor AND wafer AND (resin OR polymer) AND ((carbon NEAR2 (fiber OR fibre OR fibril)) NEAR7 (length OR size OR diameter OR thickness))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 08:38

S18	1604	(524/496).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/18 08:45
S19	5618	((524/542,592,602,606,612) or (525/184,420,422)).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/18 08:45
S20	3	S19 AND carrier AND semiconductor AND wafer AND (resin OR polymer) AND (carbon ADJ (fiber OR fibre OR fibril)) AND charge	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 08:45
S21	11100	(nakayama OR sugiyama OR tani).in.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/18 08:47
S22	34	S21 AND carrier AND semiconductor AND wafer AND (resin OR polymer)	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/18 09:43
S23	1	(dainichi NEAR3 shoji NEAR3 kabushiki).as.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 08:47
S24	97939	(nakayama OR sugiyama OR tani).in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 08:47
S25	0	S23 AND carrier AND semiconductor AND wafer AND (resin OR polymer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 08:47
S26	1	(carbon NEAR2 (fiber OR fibre OR fibril OR filament) NEAR5 (length OR diameter OR thickness OR size)) AND ((transport OR storage) NEAR3 carrier) AND (semiconductor NEAR2 wafer) AND (resin OR polymer)	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/18 09:45
S27	1	(carbon NEAR2 (fiber OR fibre OR fibril OR filament) NEAR5 (length OR diameter OR thickness OR size)) AND ((transport OR storage) NEAR3 carrier) AND (semiconductor NEAR2 wafer) AND (resin OR polymer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 09:44
S28	6	((carbon NEAR2 (fiber OR fibre OR fibril OR filament)) WITH (length OR diameter OR thickness OR size)) AND ((transport OR storage) NEAR3 carrier) AND (semiconductor NEAR2 wafer) AND (resin OR polymer)	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/18 09:57
S29	61	((carbon NEAR2 (fiber OR fibre OR fibril OR filament)) WITH (length OR diameter OR thickness OR size)) AND (semiconductor NEAR2 wafer) AND (resin OR polymer)	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/18 09:57
S30	71	((carbon NEAR2 (fiber OR fibre OR fibril OR filament)) WITH (length OR diameter OR thickness OR size)) AND (semiconductor NEAR2 wafer) AND (resin OR polymer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 09:58

S31	7	((carbon NEAR2 (fiber OR fibre OR fibril OR filament)) WITH ((length OR diameter OR thickness OR size) NEAR4 (nanometer OR nm))) AND (semiconductor NEAR2 wafer) AND (resin OR polymer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 09:58
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